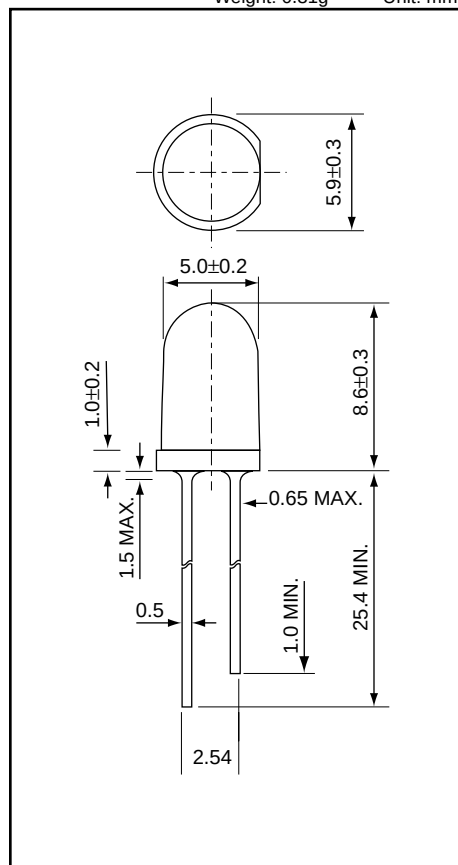




Weight: 0.31g Unit: mm



AND410HB

GaN High Intensity Blue Light Emission

- 5 mm (T1-3/4) Package
- Available on tape and reel
- Peak wavelength ($\lambda_p = 430\text{nm}$) high bright emission
- All plastic mold type, clear colorless lens
- Low drive current: 1 to 20 mA DC
- Excellent On-Off contrast ratio
- Fast response time, capable of pulse operation
- High power intensity – suitable for indoor/outdoor applications
- High reliability

Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Rating	Unit
Forward Current	I_F	30	mA
Reverse Voltage	V_R	5	V
Power Dissipation	P_D	140	mW
Operating Temperature Range	T_{Opr}	-40 to 85	C
Storage Temperature Range	T_{Sig}	-40 to 100	C

Electro-Optical Characteristics ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	V_F	$I_F = 20\text{ mA}$	–	3.8	4.5	V
Reverse Current	I_R	$V_R = 5\text{ V}$	–	–	10	μA
Luminous Intensity	I_V	$I_F = 20\text{ mA}$	250.0	400.0	–	mcd
Peak Emission Wavelength	λ_p	$I_F = 20\text{ mA}$	–	430	–	nm
Spectral Line Half Width	$\Delta\lambda$	$I_F = 20\text{ mA}$	–	65	–	nm
Dominant Wavelength	λ_d	$I_F = 20\text{ mA}$	464	–	468	nm
Full Viewing Angle	$2\theta_{1/2}$	$I_V = 1/2\text{ Peak}$	–	10	–	degree

Precaution

Please be careful of the following:

1. Soldering temperature: 260 C max.
Soldering time: 5 sec. max.
Soldering portion of lead: up to 1.6 mm from the body of the device
2. The lead can be formed up to 5 mm from the body of the device without forming stress.
Soldering should be performed after the lead forming.
3. Absolute secure counter measures against static electricity and surge should be taken when handling these products. It is recommended to use wrist band or antistatic gloves when handling these LEDs.

